

# Asymmetric thyristors

# A198 S

## HIGH POWER THYRISTOR FOR PHASE CONTROL APPLICATIONS

### Features:

- . All Diffused Structure
- . Center Amplifying Gate Configuration
- . Blocking capability up to 2000 volts
- . Guaranteed Maximum Turn-Off Time
- . High dV/dt Capability
- . Pressure Assembled Device

## ELECTRICAL CHARACTERISTICS AND RATINGS

### Blocking - Off State

$V_{RRM}$ (1)	$V_{DRM}$ (1)	$V_{RSM}$ (1)
15	1000	15

- $V_{RRM}$  = Repetitive peak reverse voltage  
 $V_{DRM}$  = Repetitive peak off state voltage  
 $V_{RSM}$  = Non repetitive peak reverse voltage (2)

Repetitive peak reverse leakage and off state leakage	$I_{RRM} / I_{DRM}$	5 mA 40 mA (3)
Critical rate of voltage rise (4)	dV/dt	1000 V/ $\mu$ sec

### Notes:

All ratings are specified for  $T_j=25^\circ\text{C}$  unless otherwise stated.

- (1) All voltage ratings are specified for an applied 50Hz/60Hz sinusoidal waveform over the temperature range  $-40$  to  $+125^\circ\text{C}$ .
- (2) 10 msec. max. pulse width
- (3) Maximum value for  $T_j = 125^\circ\text{C}$ .
- (4) Minimum value for linear and exponential waveshape to 80% rated  $V_{DRM}$ . Gate open.  $T_j = 125^\circ\text{C}$ .
- (5) Non-repetitive value.
- (6) The value of di/dt is established in accordance with EIA/NIMA Standard RS-397, Section 5-2-2-6. The value defined would be in addition to that obtained from a snubber circuit, comprising a 0.2  $\mu\text{F}$  capacitor and 20 ohms resistance in parallel with the thyristor under test.

### Conducting - on state

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Average value of on-state current	$I_{T(AV)}$		198		A	Sinewave, $180^\circ$ conduction, $T_c = 85^\circ\text{C}$
RMS value of on-state current	$I_{TRMS}$		400		A	Nominal value
Peak one cycle surge (non repetitive) current	$I_{TSM}$		-		A	8.3 msec (60Hz), sinusoidal waveshape, $180^\circ$ conduction, $T_j = 125^\circ\text{C}$
			2700		A	10.0 msec (50Hz), sinusoidal waveshape, $180^\circ$ conduction, $T_j = 125^\circ\text{C}$
I square t	$I^2t$		7600		$\text{A}^2\text{s}$	8.3 msec and 10.0 msec
Latching current	$I_L$		-		mA	$V_D = 24\text{ V}$ ; $R_L = 12\text{ ohms}$
Holding current	$I_H$		1000		mA	$V_D = 24\text{ V}$ ; $I = 2.5\text{ A}$
Peak on-state voltage	$V_{TM}$		2.0		V	$I_{TM} = 250\text{ A}$ ; Duty cycle $\leq 0.01\%$
Critical rate of rise of on-state current (5, 6)	di/dt		-		A/ $\mu\text{s}$	Switching from $V_{DRM} \leq 1000\text{ V}$ , non-repetitive
Critical rate of rise of on-state current (6)	di/dt		400		A/ $\mu\text{s}$	Switching from $V_{DRM} \leq 1000\text{ V}$



**ELECTRICAL CHARACTERISTICS AND RATINGS**
**Gating**

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Peak gate power dissipation	$P_{GM}$		30		W	$t_p = 40 \mu s$
Average gate power dissipation	$P_{G(AV)}$		10		W	
Peak gate current	$I_{GM}$		-		A	
Gate current required to trigger all units	$I_{GT}$		300		mA mA mA	$V_D = 6 V; R_L = 3 \text{ ohms}; T_j = -40^\circ C$ $V_D = 6 V; R_L = 3 \text{ ohms}; T_j = +25^\circ C$ $V_D = 6 V; R_L = 3 \text{ ohms}; T_j = +125^\circ C$
Gate voltage required to trigger all units	$V_{GT}$		- 2.7		V V V	$V_D = 6 V; R_L = 3 \text{ ohms}; T_j = -40^\circ C$ $V_D = 6 V; R_L = 3 \text{ ohms}; T_j = 0-125^\circ C$ $V_D = \text{Rated } V_{DRM}; R_L = 1000 \text{ ohms}; T_j = +125^\circ C$
Peak negative voltage	$V_{GRM}$		-		V	

**Dynamic**

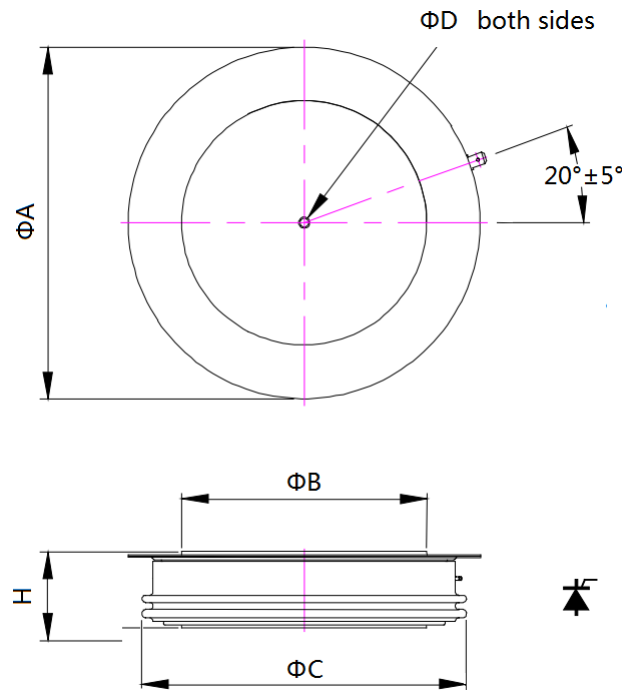
Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Delay time	$t_d$			1	$\mu s$	$I_{TM} = 50 A; V_D = \text{Rated } V_{DRM}$ Gate pulse: $V_G = 20 V; R_G = 20 \text{ ohms}; t_r = 0.1 \mu s; t_p = 20 \mu s$
Turn-off time (with $V_R = -50 V$ )	$t_q$	-	-	15	$\mu s$	$I_{TM} = 500 A; di/dt = 25 A/\mu s;$ $V_R \geq -50 V; \text{Re-applied } dV/dt = 20 V/\mu s \text{ linear to } 80\% V_{DRM}; V_G = 0;$ $T_j = 125^\circ C; \text{Duty cPSTCle} \geq 0.01\%$
Reverse recovery charge	$Q_{rr}$		*		$\mu C$	$I_{TM} = 500 A; di/dt = 25 A/\mu s;$ $V_R \geq -50 V$

\* For guaranteed max. value, contact factory.

**THERMAL AND MECHANICAL CHARACTERISTICS AND RATINGS**

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Operating temperature	$T_j$	-40	+125		$^\circ C$	
Storage temperature	$T_{stg}$	-40	+150		$^\circ C$	
Thermal resistance - junction to case	$R_{\theta(j-c)}$			117 -	K/KW	Double sided cooled * Single sided cooled *
Thermal resistance - case to sink	$R_{\theta(c-s)}$			- -	K/KW	Double sided cooled * Single sided cooled *
Thermal resistance - junction to sink	$R_{\theta(j-s)}$			- -	K/KW	Double sided cooled * Single sided cooled *
Mounting force	P	5	9	-	kN	
Weight	W			-	g	

OUTLINE



Sym	A	B	C	D	H
mm	41	25	40	3.5x1.8	14±1